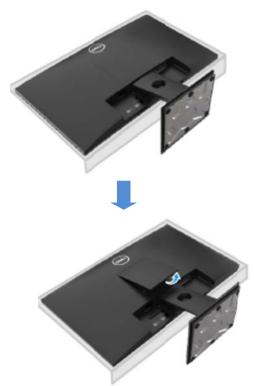
1. Disassembly Procedures

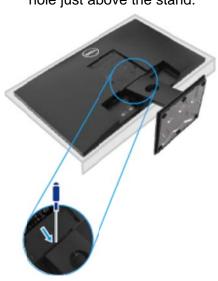
S1 Turn off the monitor.

S2 Place the monitor on a soft cloth along the desk.

Remove VESA cover to access the release button.



 Use a long and thin screwdriver to push the release latch located in a hole just above the stand.



Once the latch is released, remove the base away from the monitor.

Press down on the quick release tab latch on the bottom of the base to separate base from stand column.



S5 Unlock 4 screws on Rear Cover



(Screw Torque: 8~10kgf)

S6 Unlock 2 CLMN screws

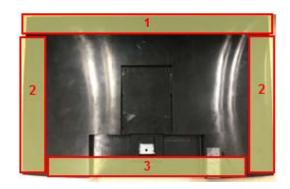


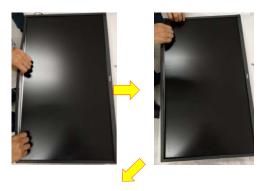
(Screw Torque: 4.5±0.5kgf)

S7 Disassemble Rear Cover from the monitor

Notice the disassembly order:

- 1) Disassemble the Top part
- 2) Disassemble the Left / Right part
- 3) Disassemble the Bottom part
- 4) Separate RC from Bezel







Remove Control BD FFC cable from I/F BD

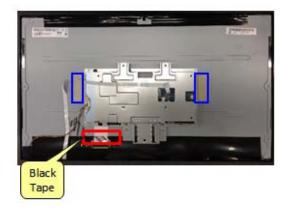


Remove 2 tapes from LVDS cable and backlight wire

Remove LVDS cable from panel

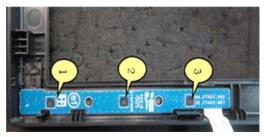
Remove backlight wire from panel and SPS BD

Remove 2 tape from Main SHD and panel



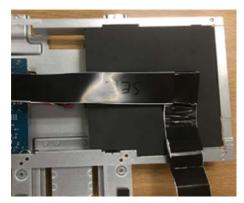
\$10 Disassemble Bezel from the panel

Unlock 3 screws on Control BD to take off Control BD from Bezel

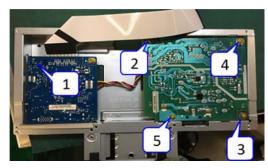


(Screw Torque: 0.9~1kgf)

S11 Disassemble Mylar from Main SHD



S12 Unlock 5 PCBA screws and 2 hex screws



(Screw Torque: 6.5±1.0kgf)



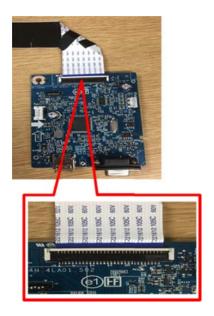
(Screw Torque: 5.0±0.6kgf)

S13 Disassemble SPS BD and I/F BD from Main SHD

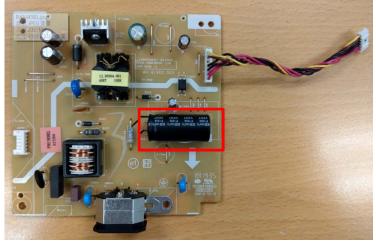


Remove SPS wire from I/F BD

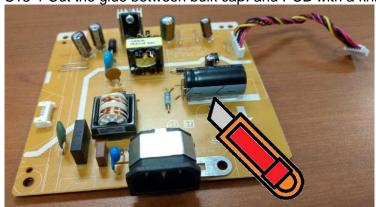
Remove LVDS cable from I/F BD



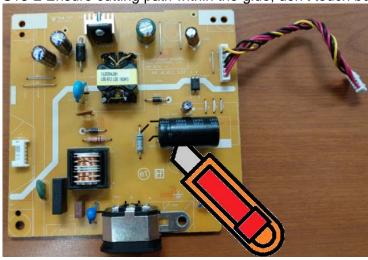
S15 Remove electrolyte capacitors (red mark) from printed circuit boards



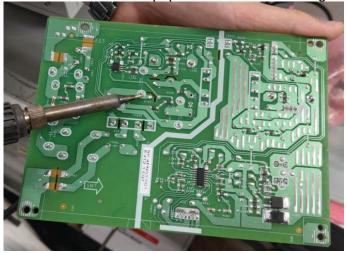
S15-1 Cut the glue between bulk cap. and PCB with a knife



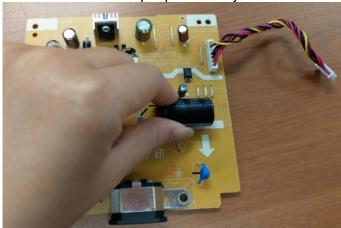
S15-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB



S15-3 Take out bulk cap. pin solder with soldering iron and absorber



S15-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater	Product has printed circuit boards
than 10 square cm)	(with a surface greater than 10 square
	cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and	No used
HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height >25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Scraper Bar
- Penknife
- Soldering iron and absorber